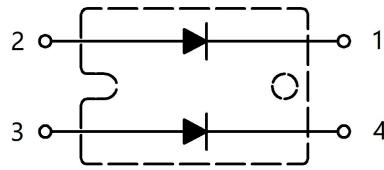


Fast Recovery Diode Module

| Symbol | Value | Unit |
|-----------|-------|------|
| V_R | 600 | V |
| I_{FAV} | 200 | A |



Features

- Ultra-Fast Reverse Recovery Time
- Soft Reverse Recovery Characteristics
- Low Reverse Recovery Loss
- High System Power Density

Applications

- Inversion Welder
- Power Factor Correction(PFC)Circuit
- Plating Power Supply
- Ultrasonic Cleaner And Welder
- Converter & Chopper

Maximum Ratings

| Symbol | Item | Conditions | Values | Unit |
|------------|------------------------------------|---|-------------|----------------------|
| V_R | Maximum D.C. Reverse Voltage | - | 600 | V |
| V_{RRM} | Maximum Repetitive Reverse Voltage | - | | |
| I_{FAV} | Average Forward Current | Rectangular, $d=0.5$, $T_c=93^\circ\text{C}$, Per Leg | 100 | A |
| | | Rectangular, $d=0.5$, $T_c=93^\circ\text{C}$, Per Module | 200 | |
| I_{FRMS} | RMS Forward Current | $T_c=93^\circ\text{C}$, Per Leg | 141 | A |
| I_{FSM} | Non-Repetitive Peak Surge Current | $t=50\text{Hz}(10\text{ms})$, $V_R=0\text{V}$, Per Leg, $T_j=25^\circ\text{C}$ | 1500 | A |
| I^2t | Circuit Fusing Consideration | $t=10\text{ms}$, $T_j=25^\circ\text{C}$ | 11250 | A^2s |
| V_{ISO} | Isolation Breakdown Voltage | AC 50Hz/60Hz, R.M.S, 1min | 3000 | V |
| P_{tot} | Total Power Dissipation | $T_j=25^\circ\text{C}$ | 417 | W |
| T_j | Operating Junction Temperature | - | -40 to +150 | $^\circ\text{C}$ |
| T_{stg} | Storage Temperature | - | -40 to +125 | $^\circ\text{C}$ |
| M_t | Mounting Torque | To Terminals(M4) | 0.7~1.1 | N·m |
| M_s | | To Heatsink(M4) | 0.7~1.1 | |
| Weight | Module (Approximately) | - | 34 | g |

Thermal Characteristics

| Symbol | Item | Conditions | Values | Unit |
|---------------|------------------------|---------------------------|--------|---------------------------|
| $R_{th(j-c)}$ | Thermal Impedance, Max | Junction to Case(Per Leg) | 0.3 | $^\circ\text{C}/\text{W}$ |
| $R_{th(c-s)}$ | Thermal Impedance, Max | Case to Heat Sink | 0.1 | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics

| Symbol | Item | Conditions | Values | | | Unit |
|-----------|--|---|--------|------|------|------------|
| | | | Min. | Typ. | Max. | |
| V_{FM} | Forward Voltage Drop Per Leg, Max | $T_j=25^\circ\text{C}$, $I_F=100\text{A}$ | - | - | 1.35 | V |
| I_{RRM} | Repetitive Peak Reverse Current Per Leg, Max | $T_j=25^\circ\text{C}$, $V_R=V_{RRM}$ | - | - | 0.2 | mA |
| | | $T_j=150^\circ\text{C}$, $V_R=V_{RRM}$ | - | - | 5 | |
| t_{rr} | Typical Reverse Recovery Time Per Leg | $I_F=0.5\text{A}$, $I_R=-1\text{A}$, $I_{RR}=-0.25\text{A}$ | - | 80 | - | ns |
| t_{rr} | Reverse Recovery Time | $I_F=100\text{A}$, $V_R=300\text{V}$, $di_F/dt=-200\text{A}/\mu\text{s}$, $T_j=25^\circ\text{C}$ | - | 80 | - | ns |
| I_{RM} | Maximum Reverse Recovery Current | $I_F=100\text{A}$, $V_R=300\text{V}$, $di_F/dt=-200\text{A}/\mu\text{s}$, $T_j=25^\circ\text{C}$ | - | 12 | - | A |
| t_{rr} | Reverse Recovery Time | $I_F=100\text{A}$, $V_R=300\text{V}$, $di_F/dt=-200\text{A}/\mu\text{s}$, $T_j=125^\circ\text{C}$ | - | 170 | - | ns |
| I_{RM} | Maximum Reverse Recovery Current | $I_F=100\text{A}$, $V_R=300\text{V}$, $di_F/dt=-200\text{A}/\mu\text{s}$, $T_j=125^\circ\text{C}$ | - | 18 | - | A |
| V_{T0} | Threshold Voltage, for power loss calculation only | $T_j=125^\circ\text{C}$ | 0.6 | | | V |
| r_T | Slope Resistance, for power loss calculation only | $T_j=125^\circ\text{C}$ | 6.5 | | | m Ω |

Characteristics Diagram

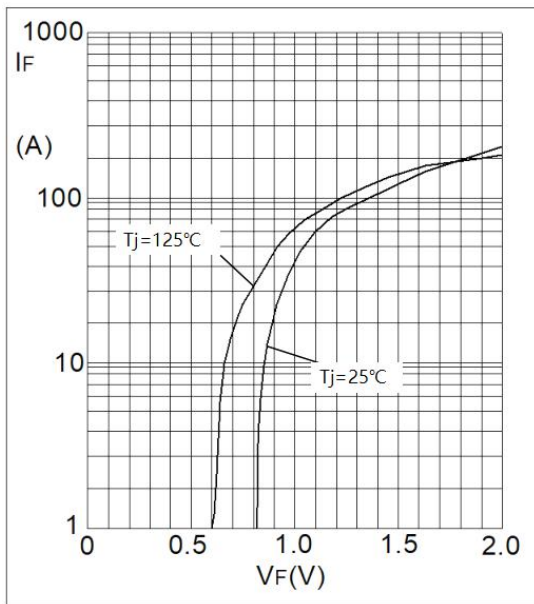


Fig1. Forward Characteristics

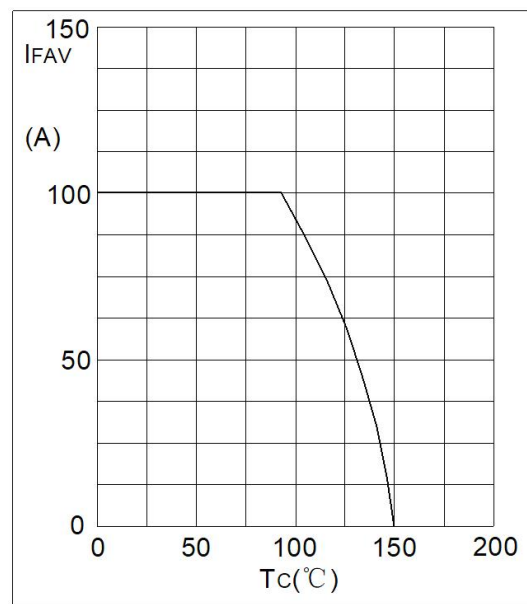


Fig2. Forward Current Derating Curve

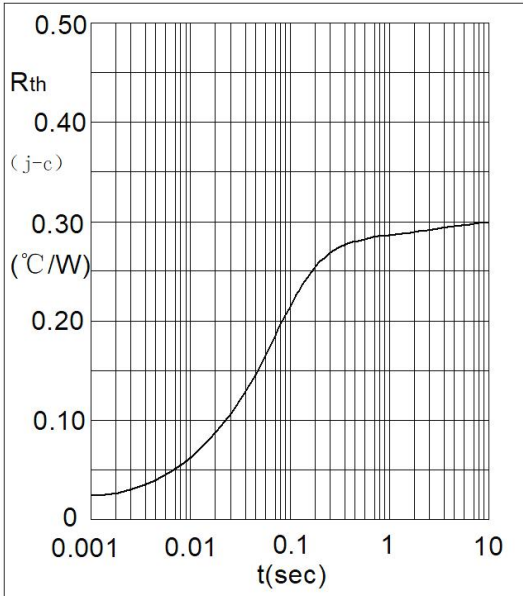


Fig3. Transient Thermal Impedance

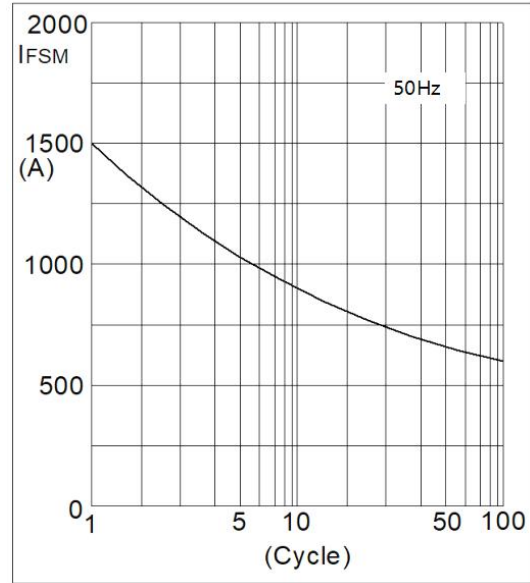


Fig4. Max Non-Repetitive Forward Surge Current

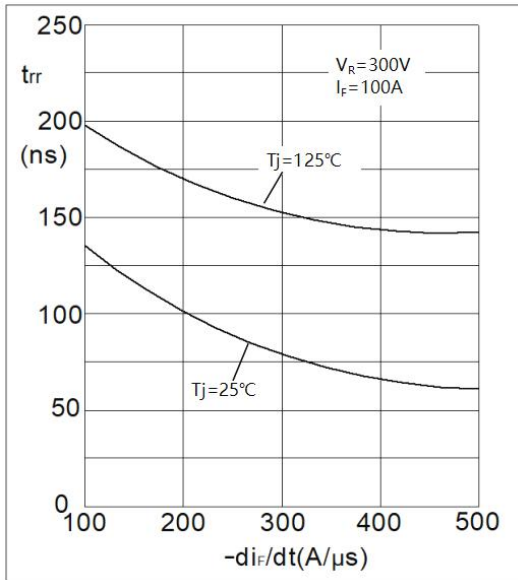


Fig5. Reverse Recovery Time VS di_F/dt

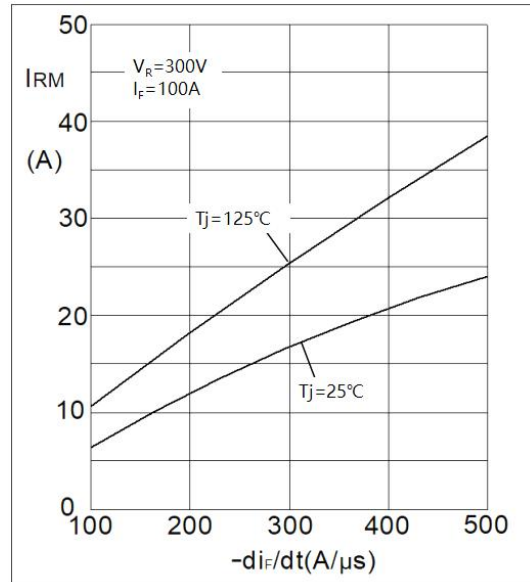


Fig6. Reverse Recovery Current VS di_F/dt

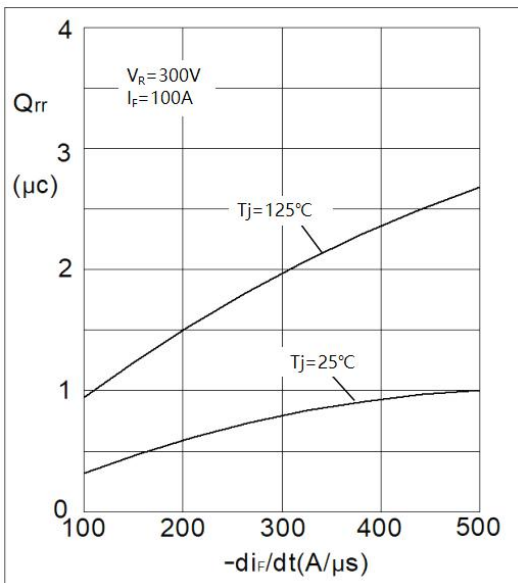
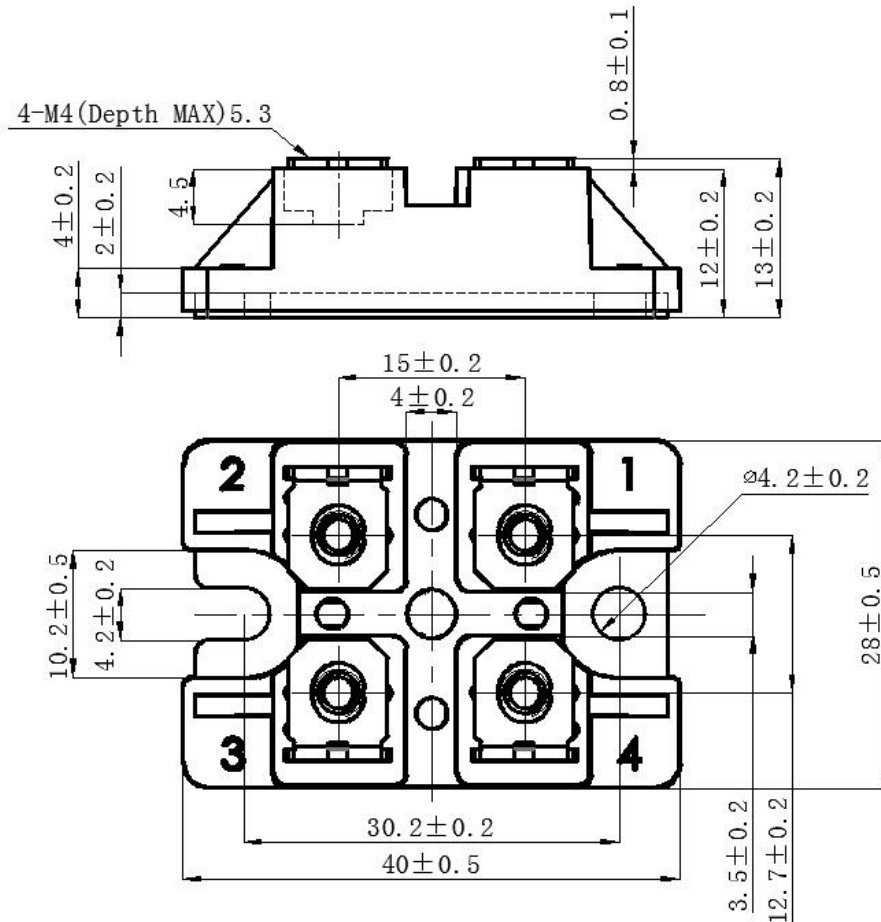


Fig7. Reverse Recovery Charge VS di_F/dt

Package Outlines M58 (Dimensions in mm)



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